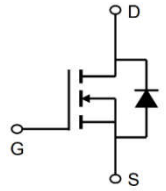
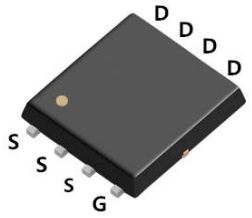
## 30V N-CHANNEL ENHANCEMENT MODE MOSFET

### MAIN CHARACTERISTICS

| | |
|---|---|
| $I_D$ | 120A |
| $V_{DSS}$ | 30V |
| $R_{DSON}$-typ(@$V_{GS}$=10V) | < 2.4mΩ(Type:1.5mΩ) |




PDFN5*6-8L

### Application

- Lithium battery protection
- Wireless impact
- Mobile phone fast charging

### Product Specification Classification

| Part Number | Package | Marking | Pack |
|---|---|---|---|
| YFW120N03NF | PDFN5*6-8L | YFW 120N03NF XXXXX | 5000PCS/Tape |

### Maximum Ratings at Tc=25°C unless otherwise specified

| Characteristics | Symbols | Value | Units |
|---|---|---|---|
| Drain-Source Voltage | $V_{DS}$ | 30 | V |
| Gate - Source Voltage | $V_{GS}$ | ±20 | V |
| Continuous Drain Current, $V_{GS}$ @ 10V[1,6] @$T_C$=25℃ | $I_D$ | 120 | A |
| Continuous Drain Current, $V_{GS}$ @ 10V[1,6] @$T_C$=100℃ | $I_D$ | 66 | A |
| Pulsed Drain Current [2] | $I_{DM}$ | 320 | A |
| Single Pulsed Avalanche Energy [3] | $E_{AS}$ | 180 | mJ |
| Avalanche Current | $I_{AS}$ | 60 | A |
| Total Power Dissipation[4] @$T_C$=25℃ | $P_D$ | 187 | W |
| Storage Temperature Range | $T_{STG}$ | -55 to +150 | °C |
| Operating Junction Temperature Range | $T_J$ | -55 to +150 | °C |
| Thermal Resistance Junction-ambient [1] | $R_{\theta JA}$ | 62 | °C/W |
| Thermal Resistance, Junction - Case[1] | $R_{\theta JC}$ | 1.1 | °C/W |

## Maximum Ratings at Tc=25°C unless otherwise specified

| Characteristics | Test Condition | Symbols | Min | Typ | Max | Units |
|---|---|---|---|---|---|---|
| Drain-Source Breakdown Voltage | $V_{GS}$=0V, $I_D$=250uA | $BV_{DSS}$ | 30 | 32 | - | V |
| BVDSS Temperature Coefficient | Reference to 25℃ , ID=1mA | $\Delta BVDSS/\Delta TJ$ | - | 0.014 | - | V/°C |
| Static Drain-Source On-Resistance [2] | $V_{GS}$=10V, $I_D$=30A | $R_{DS(ON)}$ | - | 1.5 | 2.4 | mΩ |
| | $V_{GS}$=4.5V, $I_D$=15A | | - | 2.5 | 4.5 | |
| Gate -Threshold Voltage | $V_{DS}$=$V_{GS}$, $I_D$=250uA | $V_{GS(th)}$ | 1.2 | 1.5 | 2.5 | V |
| $V_{GS}$(th) Temperature Coefficient | | $\Delta V_{GS(th)}$ | - | -4 | - | mV/°C |
| Drain-Source Leakage Current | $V_{DS}$=24V , $V_{GS}$=0V , $T_J$=25℃ | $I_{DSS}$ | - | - | 1 | μA |
| | $V_{DS}$=24V , $V_{GS}$=0V , $T_J$=55℃ | | - | - | 5 | |
| Gate –Source Leakage Current | $V_{GS}$=±20V, $V_{DS}$=0V | $I_{GSS}$ | - | - | ±100 | nA |
| Forward Transconductance | $V_{DS}$=5V , $I_D$=30A | $g_{fs}$ | - | 50 | - | S |
| Gate Resistance | $V_{DS}$=0V , $V_{GS}$=0V , f=1MHz | $R_g$ | - | 1.7 | - | Ω |
| Total Gate Charge(4.5V) | $V_{DS}$=15V<br>$I_D$=15A<br>$V_{GS}$=10V | $Q_g$ | - | 56.9 | - | nC |
| Gate-Source Charge | | $Q_{gs}$ | - | 13.8 | - | |
| Gate-Drain Charge | | $Q_{gd}$ | - | 23.5 | - | |
| Turn-on delay time | $V_{DD}$ =15V<br>$V_{GS}$=10V<br>$I_D$= 1A<br>$R_G$=3.3Ω | $t_{d(on)}$ | - | 20.1 | - | ns |
| Rise Time | | $T_r$ | - | 6.3 | - | |
| Turn-Off Delay Time | | $t_{d(OFF)}$ | - | 124.6 | - | |
| Fall Time | | $t_f$ | - | 15.8 | - | |
| Input Capacitance | $V_{DS}$=15V<br>$V_{GS}$=0V<br>f=1.0MHz | $C_{iss}$ | - | 4345 | - | pF |
| Output Capacitance | | $C_{oss}$ | - | 340 | - | |
| Reverse Transfer Capacitance | | $C_{rss}$ | - | 225 | - | |
| Continuous Source Current[1,6] | $V_G$=$V_D$=0V , Force Current | $I_S$ | - | - | 85 | A |
| Diode Forward Voltage[2] | $V_{GS}$=0V , $I_S$=1A , $T_J$=25℃ | $V_{SD}$ | - | - | 1.2 | V |

Note :
1、The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.
2、The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%
3、The EAS data shows Max. rating . The test condition is V DD =25V,V GS =10V,L=0.1mH,I AS =60A
4、The power dissipation is limited by 150℃ junction temperature
5、The data is theoretically the same as I D and I DM , in real applications , should be limited by total power dissipation.

## Ratings and Characteristic Curves

### Typical Characteristics

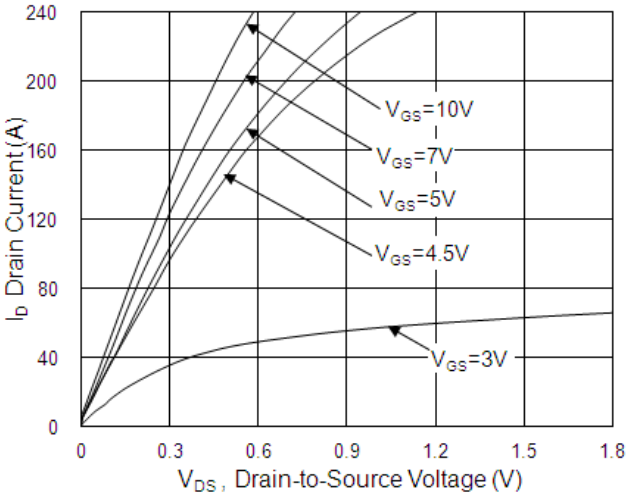



Fig.1 Typical Output Characteristics

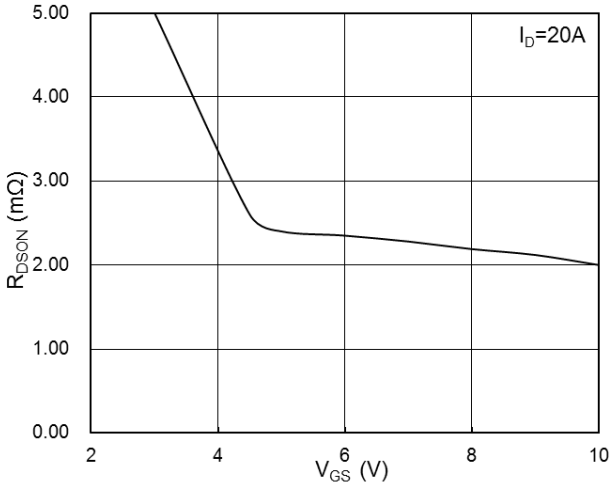



Fig.2 On-Resistance v.s Gate-Source

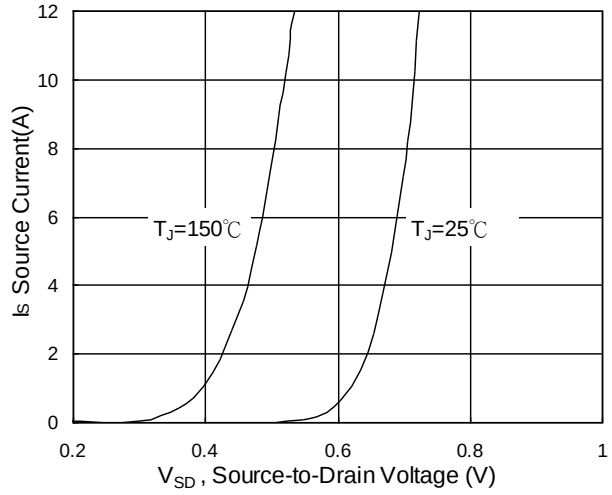



Fig.3 Forward Characteristics of Reverse

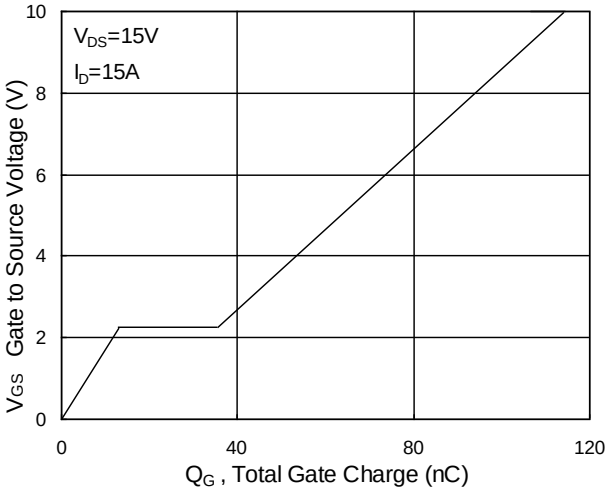



Fig.4 Gate-Charge Characteristics

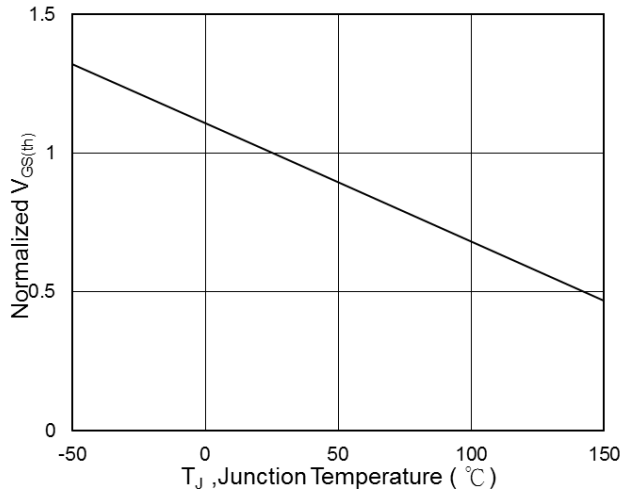



Fig.5 Normalized $V_{GS(th)}$ v.s $T_J$

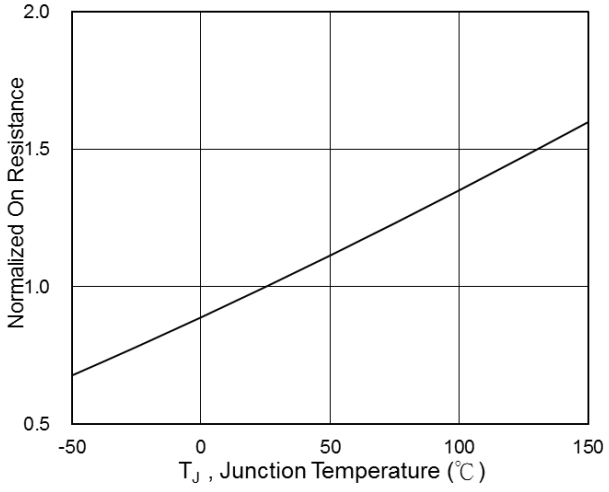



Fig.6 Normalized $R_{DSON}$ v.s $T_J$

## Ratings and Characteristic Curves

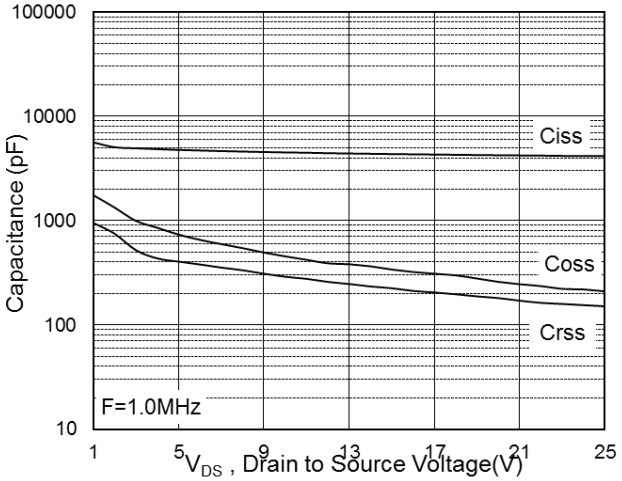



Fig.7 Capacitance

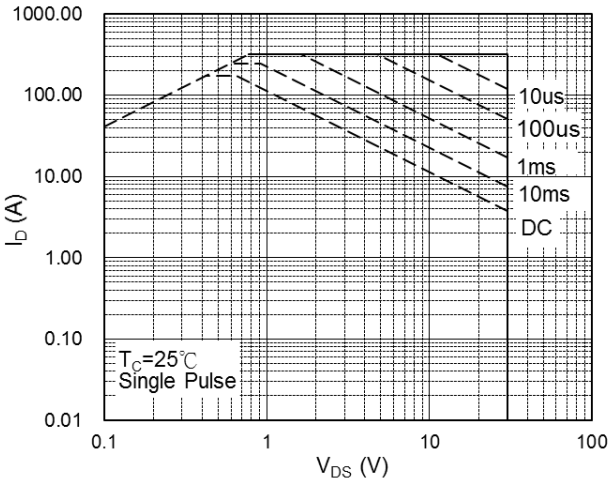



Fig.8 Safe Operating Area

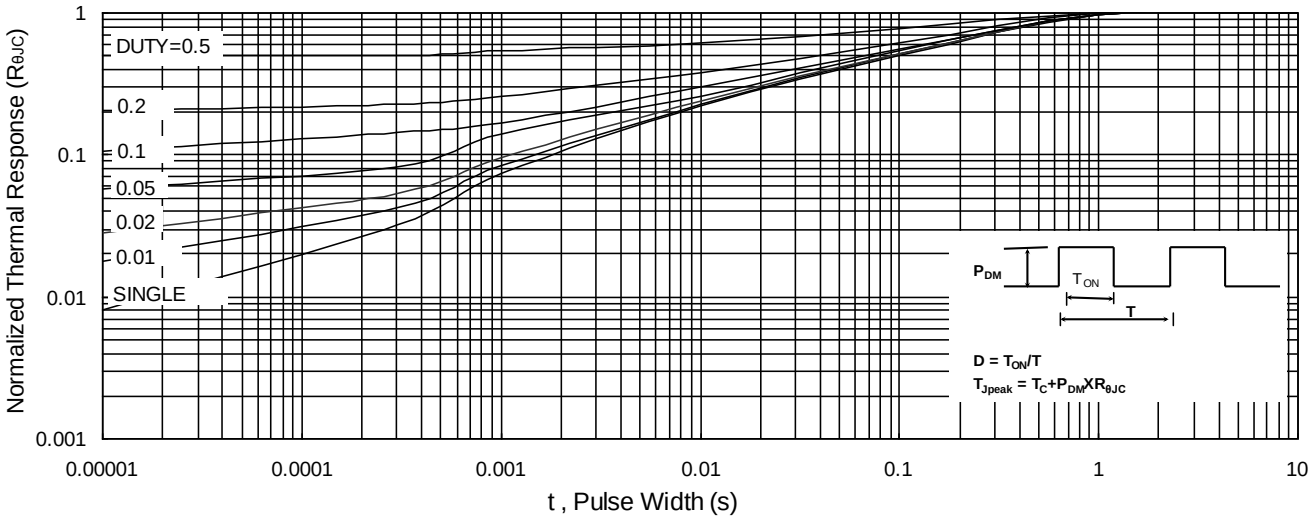



Fig.9 Normalized Maximum Transient Thermal Impedance

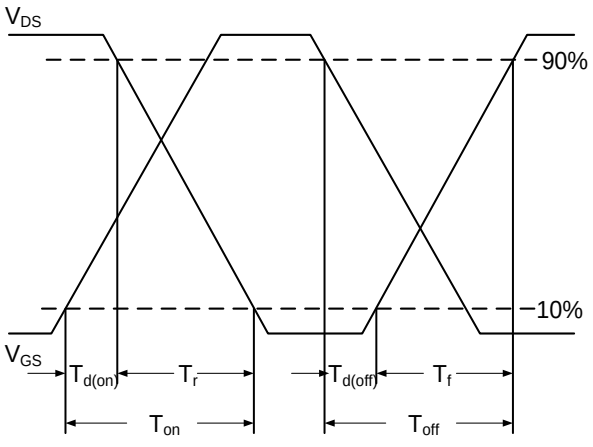



Fig.10 Switching Time Waveform

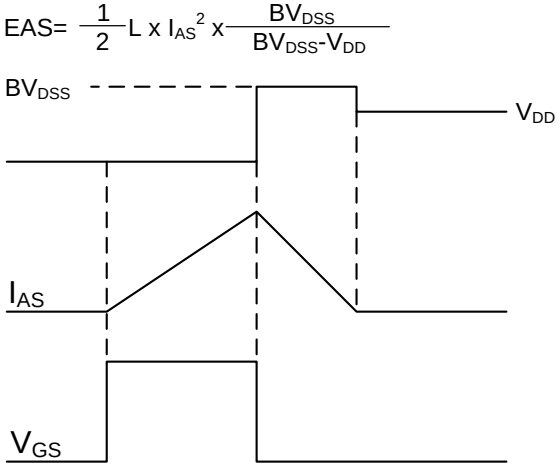
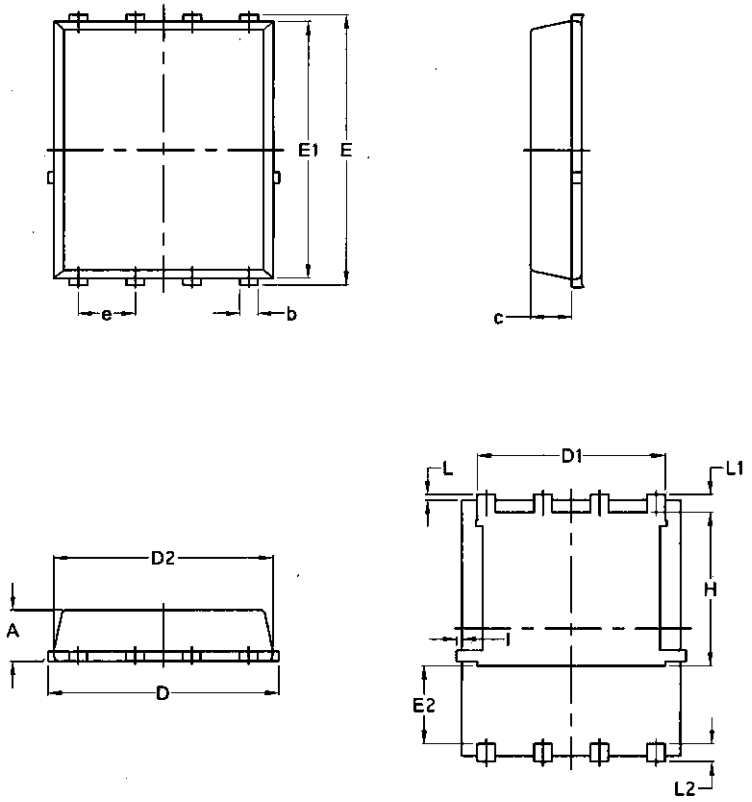



Fig.11 Unclamped Inductive Switching Waveform

## Package Outline Dimensions Millimeters

# PDFN5*6-8L




| Symbol | Common | | | |
|---|---|---|---|---|
| | mm | | Inch | |
| | Mim | Max | Min | Max |
| A | 1.03 | 1.17 | 0.0406 | 0.0461 |
| b | 0.34 | 0.48 | 0.0134 | 0.0189 |
| c | 0.824 | 0.0970 | 0.0324 | 0.082 |
| D | 4.80 | 5.40 | 0.1890 | 0.2126 |
| D1 | 4.11 | 4.31 | 0.1618 | 0.1697 |
| D2 | 4.80 | 5.00 | 0.1890 | 0.1969 |
| E | 5.95 | 6.15 | 0.2343 | 0.2421 |
| E1 | 5.65 | 5.85 | 0.2224 | 0.2303 |
| E2 | 1.60 | / | 0.0630 | / |
| e | 1.27 BSC | | 0.05 BSC | |
| L | 0.05 | 0.25 | 0.0020 | 0.0098 |
| L1 | 0.38 | 0.50 | 0.0150 | 0.0197 |
| L2 | 0.38 | 0.50 | 0.0150 | 0.0197 |
| H | 3.30 | 3.50 | 0.1299 | 0.1378 |
| I | / | 0.18 | / | 0.0070 |